

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25\text{ }^{\circ}\text{C}$.

| Parameter | Symbol | Conditions | Rating | Unit |
|---|-------------|---|------------|----------------------|
| Nonrepetitive Peak Reverse Voltage ⁽¹⁾ | V_{RSM} | | 300 | V |
| Repetitive Peak Reverse Voltage ⁽¹⁾ | V_{RM} | | 300 | V |
| Average Forward Current | $I_{F(AV)}$ | See Figure 1 and Figure 2 | 10 | A |
| Surge Forward Current ⁽¹⁾ | I_{FSM} | Half cycle sine wave, positive side, 10 ms, 1 shot | 65 | A |
| I^2t Limiting Value ⁽¹⁾ | I^2t | $1\text{ ms} \leq t \leq 10\text{ ms}$ | 21 | A^2s |
| Junction Temperature | T_J | | -40 to 150 | $^{\circ}\text{C}$ |
| Storage Temperature | T_{STG} | | -40 to 150 | $^{\circ}\text{C}$ |

Electrical Characteristics

Unless otherwise specified, $T_A = 25\text{ }^{\circ}\text{C}$.

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|---|---------------|--|------|------|------|----------------------|
| Forward Voltage Drop ⁽¹⁾ | V_F | $T_J = 25\text{ }^{\circ}\text{C}$, $I_F = 5\text{ A}$ | — | — | 1.30 | V |
| | | $T_J = 100\text{ }^{\circ}\text{C}$, $I_F = 5\text{ A}$ | — | 0.88 | — | V |
| Reverse Leakage Current ⁽¹⁾ | I_R | $V_R = V_{RM}$ | — | — | 50 | μA |
| Reverse Leakage Current under High Temperature ⁽¹⁾ | $H \cdot I_R$ | $V_R = V_{RM}$, $T_J = 150\text{ }^{\circ}\text{C}$ | — | — | 15 | mA |
| Reverse Recovery Time ⁽¹⁾ | t_{rr1} | $I_F = I_{RP} = 100\text{ mA}$, 90% recovery point, $T_J = 25\text{ }^{\circ}\text{C}$ | — | — | 30 | ns |
| | t_{rr2} | $I_F = 100\text{ mA}$, $I_{RP} = 200\text{ mA}$, 75% recovery point, $T_J = 25\text{ }^{\circ}\text{C}$ | — | — | 25 | ns |
| Thermal Resistance ⁽²⁾ | $R_{th(J-C)}$ | | — | — | 4.0 | $^{\circ}\text{C/W}$ |

Mechanical Characteristics

| Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------------------------------|------------|-------|------|-------|------|
| Heatsink Mounting Screw Torque | | 0.490 | — | 0.686 | N·m |

⁽¹⁾ Specifies a value per chip; the FMX-23S consists of two chips.

⁽²⁾ $R_{th(J-C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Rating and Characteristic Curves

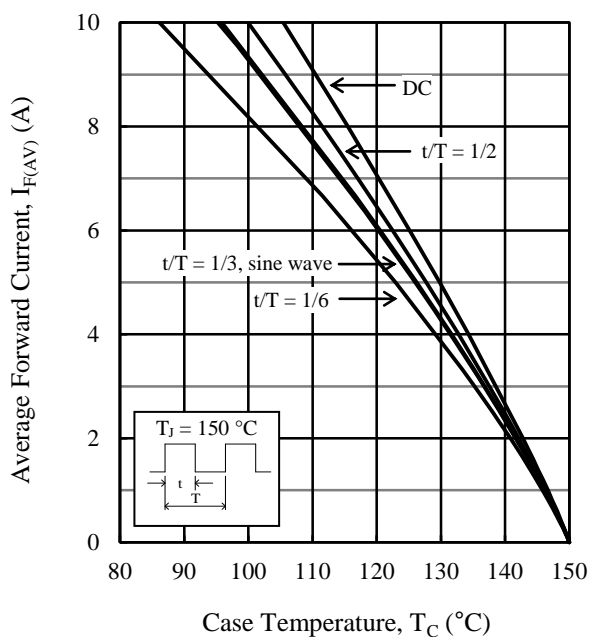


Figure 1. Typical Characteristics: $I_{F(AV)}$ vs. T_C
($V_R = 0$ V)

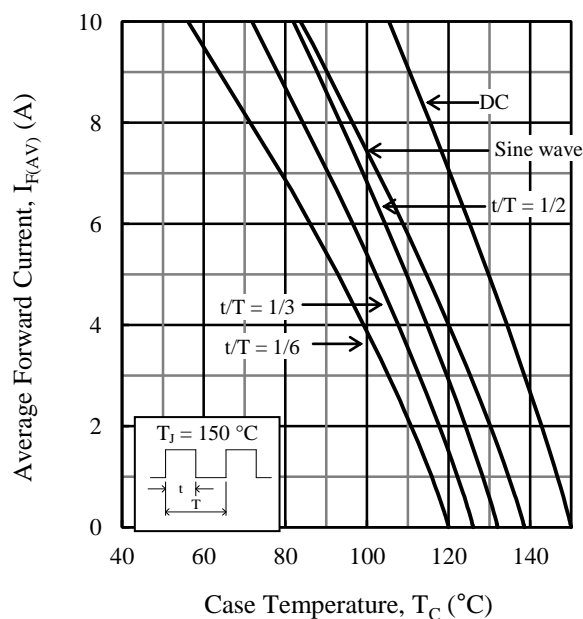


Figure 2. Typical Characteristics: $I_{F(AV)}$ vs. T_C
($V_R = 300$ V)

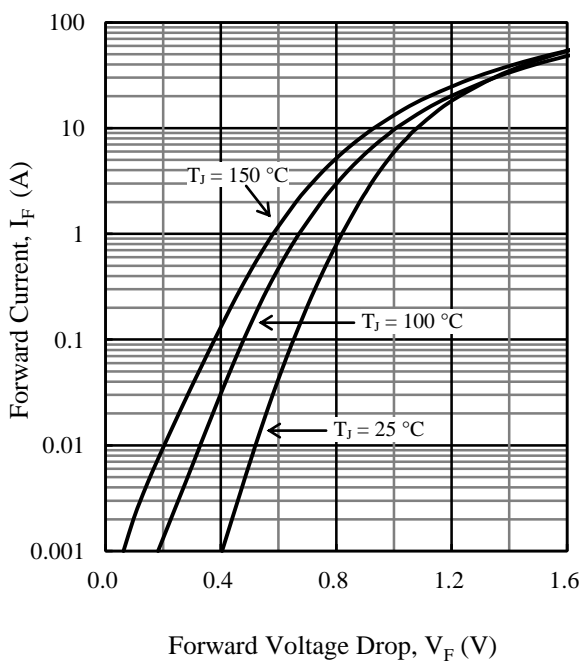


Figure 3. Typical Characteristics: I_F vs. V_F

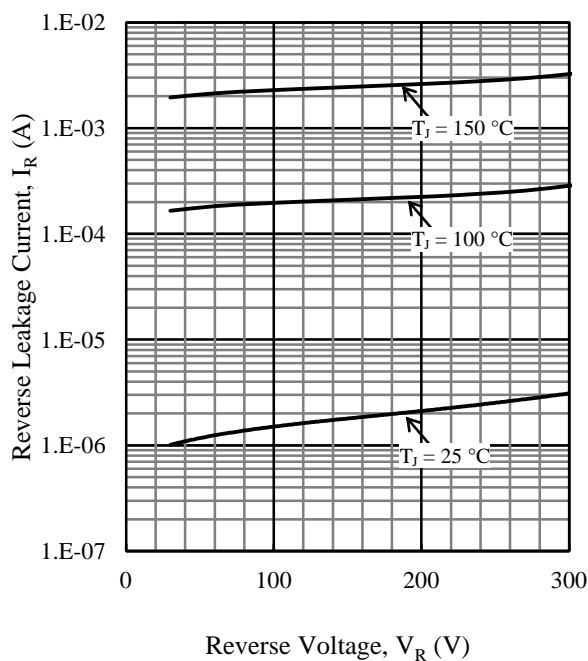
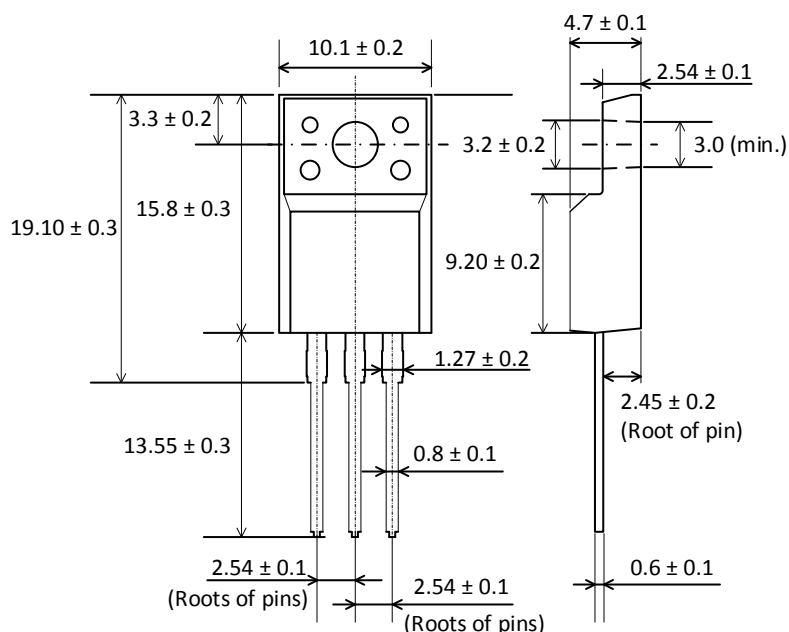


Figure 4. Typical Characteristics: I_R vs. V_R

Physical Dimensions

• TO220F-3L



NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:
 Flow: 260 ± 5 °C / 10 ± 1 s, 2 times
 Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time
 Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

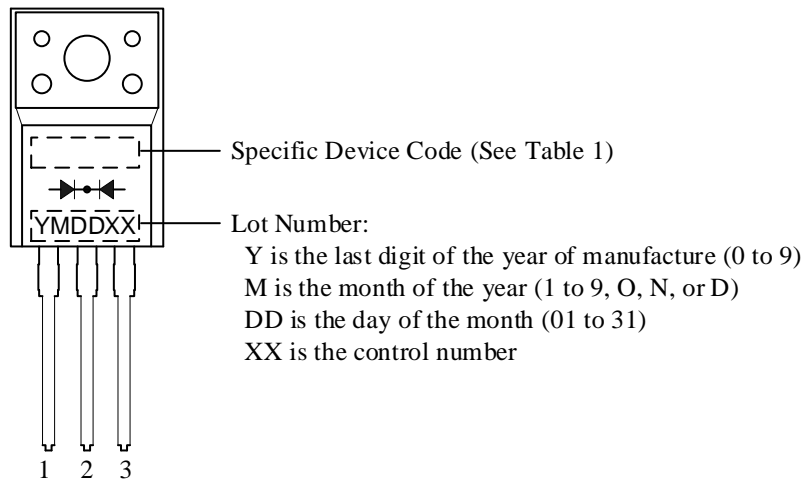


Table 1. Specific Device Code

| Specific Device Code | Part Number |
|----------------------|-------------|
| FMX23S | FMX-23S |

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